

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants : Akihiko ENDO et al.

**Attention: OIPE, Customer
Service Center**

Appln. No. : 10/569,942

Filed : February 28, 2006

For : METHOD FOR MANUFACTURING BONDED WAFER

REQUEST FOR CORRECTION OF FILING RECEIPT

Commissioner for Patents
U.S. Patent and Trademark Office
Customer Service Window, Mail Stop Missing Parts
Randolph Building
401 Dulany Street
Alexandria, VA 22314

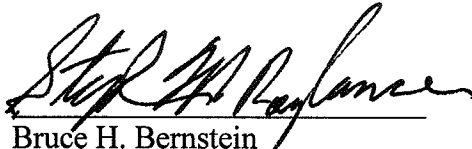
Sir:

The foreign priority filing date of the above-identified application, as it appears on the Official Filing Receipt, is incorrect. The filing date should read **September 01, 2003**, not **January 09, 2003** as it appears on the Filing Receipt. Enclosed is a copy of our date-stamped mailroom filing receipt evidencing the filing of the above-identified application on February 28, 2006, as well as a copy of the Official Filing Receipt received from the U.S. Patent and Trademark Office having the bar coded sticker with the application number and showing the correct filing date of February 28, 2006. The requested change is noted thereon. Also enclosed is the Claim of Priority filed with the above-referenced application on February 28, 2006.

Please forward a corrected filing receipt once the correction has been made. Should there be any questions, do not hesitate to contact us.

Respectfully submitted,

Akihiko ENDO et al.


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May 27, 2008
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2/28/2006

File In: Murphy

The Patent Office Date stamp hereon is an acknowledgement that, on the date indicated, the Patent Office received the following:

W Natural phase of PCT/JP2004/012633 filed Sep. 1 2004
W International Application as published in Japanese (1 page of cover sheet)

- | | |
|---|--|
| <input checked="" type="checkbox"/> Amendment <u>Preliminary</u> | <input checked="" type="checkbox"/> Claim of Priority & Certified Copy of _____ |
| <input checked="" type="checkbox"/> Executed Assignment and cover letter | |
| <input type="checkbox"/> Executed S.E.S. <input type="checkbox"/> S.E.S. Assertion | |
| <input type="checkbox"/> Req. for Ext. of Time | <input checked="" type="checkbox"/> Declaration <input checked="" type="checkbox"/> Executed |
| <input checked="" type="checkbox"/> Fee Filing <input checked="" type="checkbox"/> | <input type="checkbox"/> Unexecuted |
| Recording <input checked="" type="checkbox"/> | <input type="checkbox"/> Copy from parent |
| Issue <input type="checkbox"/> | <input checked="" type="checkbox"/> Transmittal Letter |
| Extension <input type="checkbox"/> | <input checked="" type="checkbox"/> Patent Application (<u>English translation</u>) |
| Publication <input type="checkbox"/> | <input type="checkbox"/> Provisional <input type="checkbox"/> Reexam |
| | <input type="checkbox"/> Reissue <input type="checkbox"/> Design |
| <input type="checkbox"/> Fee Transmittal | <input type="checkbox"/> Continuation <input type="checkbox"/> CIP |
| <input type="checkbox"/> Maintenance Fee Payment | <input type="checkbox"/> Divisional |
| <input type="checkbox"/> PTOL-85B Issue Fee & Publication Fee (with Copy) | <u>20</u> pages (w/abstract) |
| <input type="checkbox"/> Cover Letter Regarding Drawings | <u>6</u> claims <u>1</u> independent |
| <input type="checkbox"/> Design Patent Application Transmittal | <u>3</u> sheets of drawings |
| <input type="checkbox"/> Utility Patent Application Transmittal | <u>86</u> figures |
| <input type="checkbox"/> Provisional Application Cover Sheet | <input type="checkbox"/> I.D.S. form PTO-1449 & |
| <input type="checkbox"/> Request for Continued Examination (RCE) including Submission | Documents <input type="checkbox"/> as attached |
| <input type="checkbox"/> Cover Letter | <input type="checkbox"/> as listed on reverse |
| <input type="checkbox"/> Credit Card Payment for \$ (Form PTO-2038) | <input checked="" type="checkbox"/> One self-addressed postcard |
| <input checked="" type="checkbox"/> Check No. 57278 for \$ 940.00 | <input type="checkbox"/> Certification under 1.97(e) |
| <input type="checkbox"/> Rule 53b and 53f Letter for Unexecuted Application | <input type="checkbox"/> Certificate of Mailing (C-O-M) |
| <input type="checkbox"/> Application Data Sheet | <input type="checkbox"/> Returned Envelope |

In the matter of : METHOD FOR MANUFACTURING BONDED WAFER

Applicant : Akihiko ENDO et al.

Application No. : NIT Yot Anigand

Patent No. :

Filed : currently Herewith

Issued :

Docket : P29123

W PCT/ISA/210
W PCT/IB/306
W PCT/IB/308
W PCT/RO/101 (in JP)

BH3



UNITED STATES PATENT AND TRADEMARK OFFICE

UNITED STATES DEPARTMENT OF COMMERCE
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APPLICATION NUMBER	FILING or 371(c) DATE	GRP ART UNIT	FIL FEE REC'D	ATTY DOCKET NO	TOT CLAIMS	IND CLAIMS
10/569,942	02/28/2006	2812	900	P29123	6	1

CONFIRMATION NO. 1077

7055
GREENBLUM & BERNSTEIN, P.L.C.
1950 ROLAND CLARKE PLACE
RESTON, VA 20191

FILING RECEIPT



RECEIVED

MAY 12 2008

Date Mailed: 05/12/2008

GREENBLUM & BERNSTEIN PLC

Receipt is acknowledged of this non-provisional patent application. The application will be taken up for examination in due course. Applicant will be notified as to the results of the examination. Any correspondence concerning the application must include the following identification information: the U.S. APPLICATION NUMBER, FILING DATE, NAME OF APPLICANT, and TITLE OF INVENTION. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. **If an error is noted on this Filing Receipt, please submit a written request for a Filing Receipt Correction. Please provide a copy of this Filing Receipt with the changes noted thereon. If you received a "Notice to File Missing Parts" for this application, please submit any corrections to this Filing Receipt with your reply to the Notice. When the USPTO processes the reply to the Notice, the USPTO will generate another Filing Receipt incorporating the requested corrections**

Applicant(s)

Akihiko Endo, Tokyo, JAPAN;
Hideki Nishihata, Tokyo, JAPAN;

Assignment For Published Patent Application

SUMCO CORPORATION, TOKYO, JAPAN

Power of Attorney: The patent practitioners associated with Customer Number 07055

Domestic Priority data as claimed by applicant

This application is a 371 of PCT/JP04/12633 09/01/2004

Foreign Applications

JAPAN 2003-309239 01/09/2003



If Required, Foreign Filing License Granted: 05/05/2008

The country code and number of your priority application, to be used for filing abroad under the Paris Convention, is **US 10/569,942**

Projected Publication Date: 08/21/2008

Non-Publication Request: No

Early Publication Request: No

09-01-2003



correct Priority
date

Title

Method for Manufacturing Bonded Wafer

Preliminary Class

438

PROTECTING YOUR INVENTION OUTSIDE THE UNITED STATES

Since the rights granted by a U.S. patent extend only throughout the territory of the United States and have no effect in a foreign country, an inventor who wishes patent protection in another country must apply for a patent in a specific country or in regional patent offices. Applicants may wish to consider the filing of an international application under the Patent Cooperation Treaty (PCT). An international (PCT) application generally has the same effect as a regular national patent application in each PCT-member country. The PCT process **simplifies** the filing of patent applications on the same invention in member countries, but **does not result** in a grant of "an international patent" and does not eliminate the need of applicants to file additional documents and fees in countries where patent protection is desired.

Almost every country has its own patent law, and a person desiring a patent in a particular country must make an application for patent in that country in accordance with its particular laws. Since the laws of many countries differ in various respects from the patent law of the United States, applicants are advised to seek guidance from specific foreign countries to ensure that patent rights are not lost prematurely.

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